Description

The FDD6690S uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

 $V_{DS} = 30V I_{D} = 50 A$

 $R_{DS(ON)}$ < 10m Ω @ V_{GS} =10V

Application

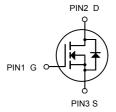
Battery protection

Load switch

Uninterruptible power supply



TO-252-2L (DPAK)



N-Channel MOSFET

Package Marking and Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|------------|------------------|------------|----------|
| FDD6690S | TO-252-2L (DPAK) | HXY MOSFET | 2500 |

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

| Symbol | Parameter | Rating | Units | |
|---------------------------------------|--|------------|-------|--|
| V _D s | Drain-Source Voltage | 30 | V | |
| V _G s | Gate-Source Voltage | ±20 | V | |
| I _D @T _C =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 50 | А | |
| I _D @T _C =100°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 30 | А | |
| I _D @T _A =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 11 | А | |
| I _D @T _A =70°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 9 | А | |
| Ідм | Pulsed Drain Current ² | 112 | А | |
| EAS | Single Pulse Avalanche Energy ³ | 24.2 | mJ | |
| las | Avalanche Current | 22 | А | |
| P _D @T _C =25°C | Total Power Dissipation ⁴ | 37.5 | W | |
| P _D @T _A =25°C | Total Power Dissipation ⁴ | 2.42 | W | |
| Тѕтс | Storage Temperature Range | -55 to 175 | °C | |
| TJ | Operating Junction Temperature Range | -55 to 175 | °C | |
| ReJA | Thermal Resistance Junction-Ambient ¹ | 62 °C/W | | |
| Rejc | Thermal Resistance Junction-Case ¹ | 4 °C/M | | |



Electrical Characteristics (T_J=25°C, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Unit | |
|------------------------|--|--|------|--------|------|-------|--|
| BVDSS | Drain-Source Breakdown Voltage | V _{GS} =0V , I _D =250uA | 30 | | | V | |
| △BVDSS/△TJ | BVDSS Temperature Coefficient | Reference to 25°C , I _D =1mA | | 0.0193 | | V/°C | |
| | Otatia Dania Ocuma On Daniatana 2 | V _{GS} =10V , I _D =30A | | 7.5 | 10 | | |
| Rds(on) | Static Drain-Source On-Resistance ² | V _{GS} =4.5V , I _D =15A | | 11 | 18 | mΩ | |
| V _{GS(th)} | Gate Threshold Voltage | | 1.2 | | 2.5 | V | |
| $\triangle V_{GS(th)}$ | V _{GS(th)} Temperature Coefficient | V _{GS} =V _{DS} , I _D =250uA | | -3.97 | | mV/°C | |
| lana | Drain-Source Leakage Current | V _{DS} =24V , V _{GS} =0V , T _J =25°C | | | 1 | | |
| IDSS | | V _{DS} =24V , V _{GS} =0V , T _J =55°C | | | 5 | uA | |
| Igss | Gate-Source Leakage Current | V_{GS} = $\pm 20V$, V_{DS} = $0V$ | | | ±100 | nA | |
| gfs | Forward Transconductance | V _{DS} =5V , I _D =30A | | 34 | | S | |
| Rg | Gate Resistance | V _{DS} =0V , V _{GS} =0V , f=1MHz | | 1.8 | | Ω | |
| Qg | Total Gate Charge (4.5V) | | | 9.8 | | | |
| Qgs | Gate-Source Charge | V _{DS} =15V , V _{GS} =4.5V , I _D =15A | | 4.2 | | nC | |
| Q_{gd} | Gate-Drain Charge | | | 3.6 | | | |
| Td(on) | Turn-On Delay Time | | | 4 | | | |
| Tr | Rise Time | V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω | | 8 | | ns | |
| T _{d(off)} | Turn-Off Delay Time | I _D =15A | | 31 | | | |
| Tf | Fall Time | | | 4 | | | |
| Ciss | Input Capacitance | | | 940 | | | |
| Coss | Output Capacitance | V _{DS} =15V , V _{GS} =0V , f=1MHz | | 131 | | pF | |
| Crss | Reverse Transfer Capacitance | | | 109 | | | |
| Is | Continuous Source Current ^{1,5} | | | | 43 | Α | |
| lsм | Pulsed Source Current ^{2,5} | V _G =V _D =0V , Force Current | | | 112 | Α | |
| VsD | Diode Forward Voltage ² | V _{GS} =0V , I _S =1A , T _J =25°C | | | 1 | V | |
| trr | Reverse Recovery Time | IF=30A, dI/dt=100A/µs , | | 8.5 | | nS | |
| Qrr | Reverse Recovery Charge | T_=30A, αι/αι=100A/μs , T_=25°C | | 2.2 | | nC | |

Note:

- 1 .The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leqq 300 us$, duty cycle $\leqq 2\%$
- 3 .The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH, I_{AS} =22A
- 4. The power dissipation is limited by 175°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

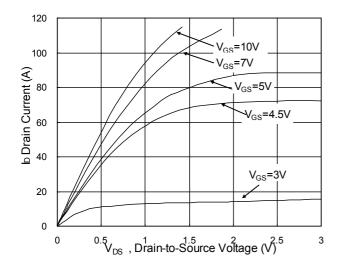


Fig.1 Typical Output Characteristics

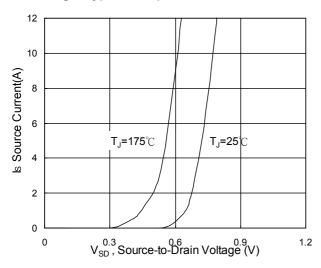


Fig.3 Forward Characteristics of Reverse

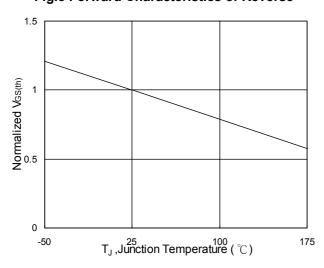


Fig.5 Normalized $V_{\text{GS(th)}}$ vs. T_{J}

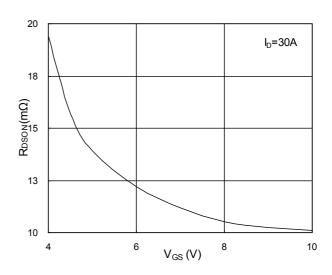


Fig.2 On-Resistance vs. G-S Voltage

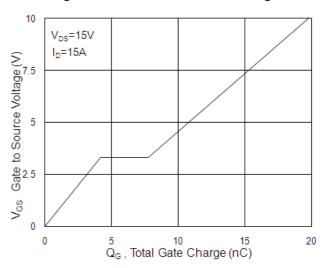


Fig.4 Gate-Charge Characteristics

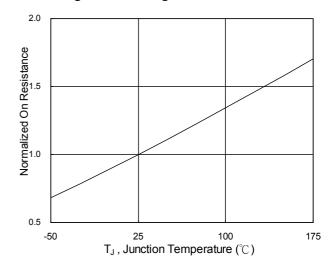
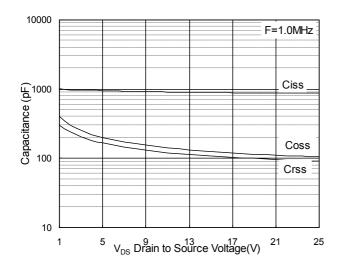


Fig.6 Normalized R_{DSON} vs. T_J





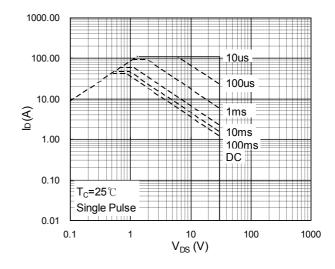


Fig.7 Capacitance

Fig.8 Safe Operating Area

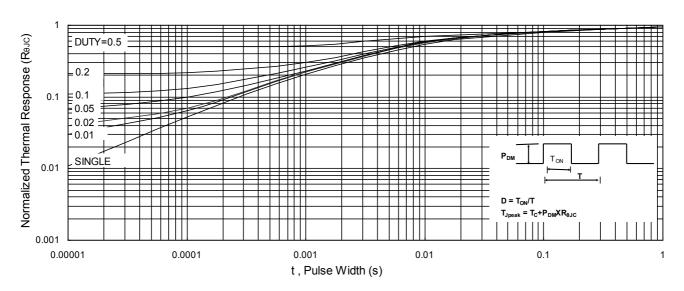
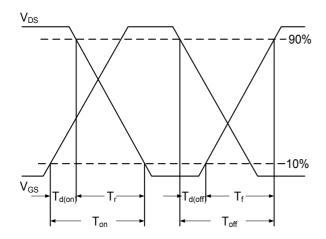


Fig.9 Normalized Maximum Transient Thermal Impedance



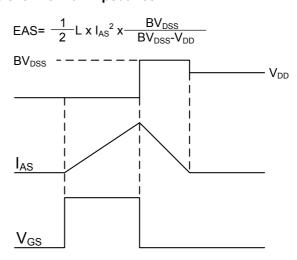
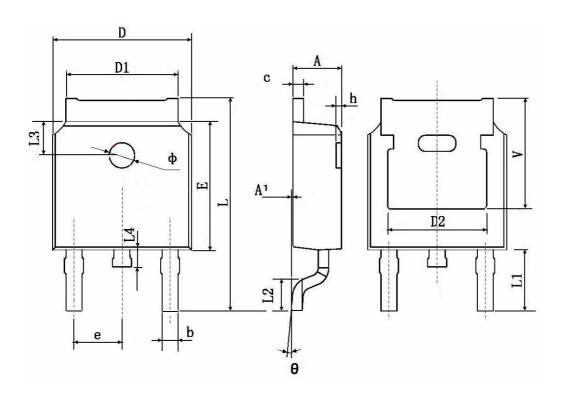


Fig.11 Unclamped Inductive Switching Waveform



TO-252-2L(DPAK) Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | | |
|--------|---------------------------|--------|----------------------|-------|--|
| | Min. | Max. | Min. | Max. | |
| А | 2.200 | 2.400 | 0.087 | 0.094 | |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 | |
| b | 0.660 | 0.860 | 0.026 | 0.034 | |
| С | 0.460 | 0.580 | 0.018 | 0.023 | |
| D | 6.500 | 6.700 | 0.256 | 0.264 | |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 | |
| D2 | 0.483 TYP. | | 0.190 TYP. | | |
| Е | 6.000 | 6.200 | 0.236 | 0.244 | |
| е | 2.186 | 2.386 | 0.086 | 0.094 | |
| L | 9.800 | 10.400 | 0.386 | 0.409 | |
| L1 | 2.900 TYP. | | 0.114 TYP. | | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 | |
| L3 | 1.600 TYP. | | 0.063 TYP. | | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 | |
| Ф | 1.100 | 1.300 | 0.043 | 0.051 | |
| θ | 0° | 8° | 0° | 8° | |
| h | 0.000 | 0.300 | 0.000 | 0.012 | |
| V | 5.350 TYP. | | 0.211 TYP. | | |



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